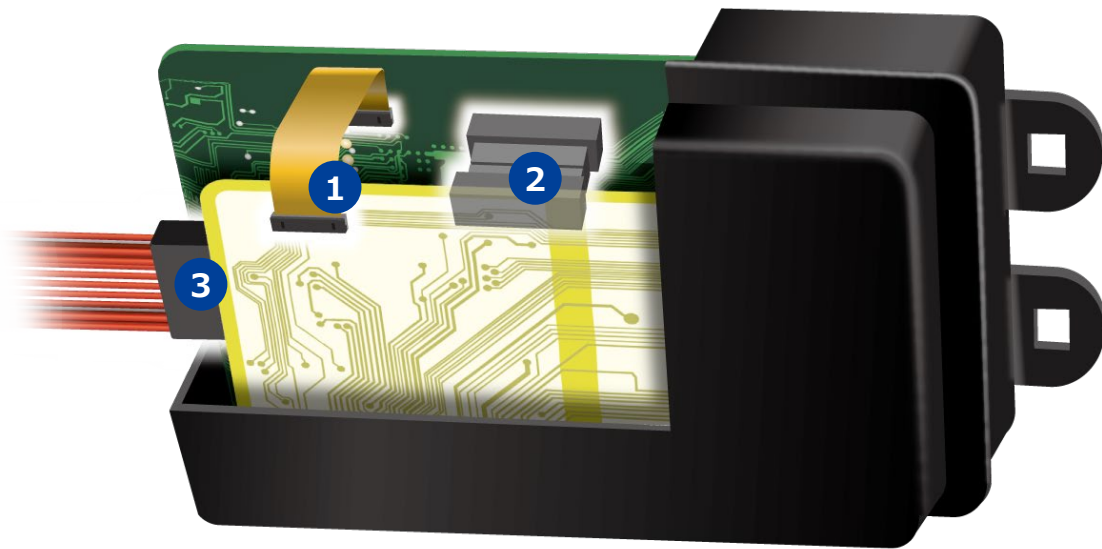
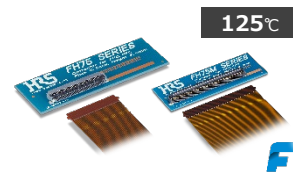




1. Internal Connection (FPC/FFC, Wire-to-Board)



125℃

FH75/FH75M

Pitch : 0.4/0.5mm
Front Flip
Two-Point Contact



Best Selling

125℃

FH52K

Pitch : 0.5/1.0mm
Height : 2.0mm

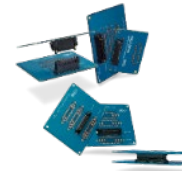


125℃

GT50

Pitch : 1.0mm
Rated Current :
1.5A (6-16pos.)/2.0A (2, 4pos.)
No. of Pos. : 2, 4, 6, 8, 12, 16
AWG : 28

2. Internal Connection (Floating Board-to Board, Board-to-Board(FPC))



FunctionMAX

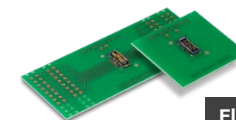
105℃

High Speed

Power / Signal

FX23/FX23L

PCIe Gen.4 (16Gbps)
Pitch : 0.5mm
Stacking Height : 8-30mm

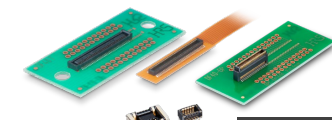


Floating Design

125℃

BM54

Floating, Compact
Pitch : 0.4mm
Stacking Height : 3.0-4.5mm

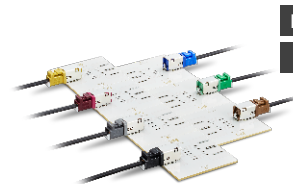


125℃

DF40T

Low Profile,
Narrow Pitch : 0.4mm
Stacking Height : 1.5-7.0mm
1.5 (Shielded Type : DF40GT)

3. Interface Connection (High Speed Wire-to-Board, Wire-to-Board)



Noise Resistant

105℃

GT43

Compact, One Step Crimping
Frequency : 3GHz
Coaxial Cable : 1.5D

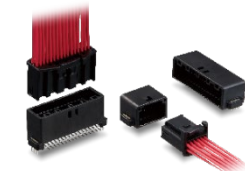


Robust

125℃

ZE05

Pitch : 2mm
Rated Current :
2A (All pins power supply)
No. of Pos. : 2-24
AWG : 20-22



105℃

GT25

Pitch : 2.2mm
Rated Current :
3A (All pins power supply)
No. of Pos. : 8-40
AWG : 20-26